PATENT ASSIGNMENT

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 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yuk L. Tsang	04/27/2007

RECEIVING PARTY DATA

Name:	Freescale Semiconductor, Inc.
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Internal Address:	Law Department
City:	Austin
State/Country:	TEXAS
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11742942

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NAME OF SUBMITTER: George R. Meyer

Total Attachments: 2

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PATENT

REEL: 019236 FRAME: 0684

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ASSIGNMENT OF U.S. PATENT APPLICATION

This is an assignment of patent rights between the inventor(s)

Yuk L. Tsang

For good and valuable consideration, the receipt of which is hereby acknowledged, I, Yuk L. Tsang have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in METHOD OF BLOCKING A VOID DURING CONTACT FORMATION PROCESS AND DEVICE HAVING THE SAME (Docket No. SC14458TP), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by me on the dates indicated by my signature below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

I hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefore in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and I further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division. extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its

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successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

I agree that, when requested, I will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

I covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, heense or other encumbrance.

This assignment is executed on the date(s) of which the Inventors have signed.

Yuk L. parg 4/27/2007

Inventors:

RECORDED: 05/02/2007

State of (XQS)
County of TVX (15

Before me personally appeared said inventor and acknowledge the foregoing instrument to be his/her

free act and deed this 27th day of April 2097

LISA ANN THOMPSON
MY COMMISSION EXPIRES
April 9, 2009